



Product Change Notification

Change Notification #: 116426 - 00

Change Title: Intel® Omni-Path Director Class Switch 100 Series 6 Slot Base 1MM 100SWD06B1N,
Intel® Omni-Path Director Class Switch 100 Series 24 Slot Base 1MM 100SWD24B1N,
Intel® Omni-Path Director Switch Management Module 100 Series 100SWDMGTSH,
Intel® Omni-Path Director Class Switch 100 Series 6 Slot FRU Chassis 100SWD06CHS,
Intel® Omni-Path Director Class Switch 100 Series 24 Slot FRU Chassis 100SWD24CHS
PCN 116426-00, Label, Label Update

Date of Publication: August 16, 2018

Key Characteristics of the Change:

Label Update

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	September 17, 2018
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The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.

Description of Change to the Customer:

Affected Product Code	Product Description
100SWD06B1N	Intel® Omni-Path Director Class Switch 100 Series 6 Slot Base 1MM 100SWD06B1N
100SWD24B1N	Intel® Omni-Path Director Class Switch 100 Series 24 Slot Base 1MM 100SWD24B1N
100SWDMGTSH	Intel® Omni-Path Director Switch Management Module 100 Series 100SWDMGTSH
100SWD06CHS	Intel® Omni-Path Director Class Switch 100 Series 6 Slot FRU Chassis 100SWD06CHS
100SWD24CHS	Intel® Omni-Path Director Class Switch 100 Series 24 Slot FRU Chassis 100SWD24CHS

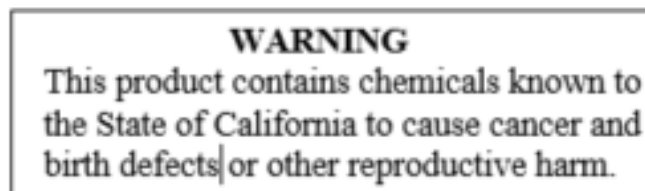
Overview of Changes:

For Intel® Omni-Path Director Class Switches and Management Modules, the generic California Proposition 65 warning statement will be removed from all labels.

Product Change Details:

For Intel® Omni-Path Director Class Switches and Management Modules, the generic California Proposition (CA Prop) 65 warning statement shown in Error! Reference source not found. below will be removed from all product and packaging labels. Based on “California Proposition 65 Information for Wire and Cable Manufacturers”, infrequently handled cords and cables as well as internal components not normally accessible to the consumer during ordinary use are exempt from the warning statement. Intel has reassessed the Omni-Path products and determined the Director Switches and Management Modules are infrequently handled, as the design intent is to install the interconnect configuration and leave it alone unless the product fails. The shortest Mean Time Between Failure (MTBF) for the entire Omni-Path product line is 13 years. Given this, Intel believes the CA Prop 65 warning statement is not applicable to the Director product series and will be removed.

Figure 1. Generic California Proposition 65 Warning Statement



Customer Impact of Change and Recommended Action:

Intel is not recommending additional qualification of these changes by customers.

There is no change to the Intel Material Master (MM) numbers or revisions.

Please contact your local Intel Field Sales Representative if you have any questions about this change.

Milestone dates are estimates and subject to change based on business and operational conditions.

* Other names and brands may be claimed as the property of others.

Products Affected / Intel Ordering Codes:

Product Code	MM#	MM# Rev	TA	AA
100SWD06B1N	945676	15	J12783-014	J11517-014
100SWD24B1N	945677	15	J12778-014	H89346-016
100SWDMGTSH	945776	08	H87892-010	H60416-013
100SWD06CHS	947192	08	J18616-007	J19700-005
100SWD24CHS	947193	08	J18618-007	J18617-005

PCN Revision History:

Date of Revision:

August 16, 2018

Revision Number:

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Reason:

Originally Published PCN



Product Change Notification

116426 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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Europe Email: eccb@intel.com

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